

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
WEIJIE WANG	05/22/2015
ZUQIN LIU	05/29/2015
SONG HAN	05/22/2015
JONATHAN BORNSTEIN	05/26/2015
CONSTANTIN IONEL STEFAN	05/22/2015
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Street Address:	225 Humboldt Court
City:	Sunnyvale
State/Country:	CALIFORNIA
Postal Code:	94089
PROPERTY NUMBERS Total: 2	
Property Type	Number
Application Number:	61992121
Application Number:	14710103
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NAME OF SUBMITTER:	LATONIA ERVIN
SIGNATURE:	/Latonia Ervin/
DATE SIGNED:	06/02/2015
Total Attachments: 2	

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PATENT

REEL: 035767 FRAME: 0644

ASSIGNMENT OF PATENT APPLICATIONS

Whereas I, an undersigned named inventor, possess the right, title and interest for and in the Invention(s) as set forth in the following patent applications:

U.S. Provisional Patent Application titled "STRUCTURALLY CONTROLLED DEPOSITION OF SILICON ONTO NANOWIRES" (Atty. Docket No. AMPRP035P), the same having been filed on May 12, 2014, as U.S. Provisional Application No. 61/992,121; and for which I have executed a U.S. Non-Provisional Patent Application titled "STRUCTURALLY CONTROLLED DEPOSITION OF SILICON ONTO NANOWIRES" (Atty. Docket No. AMPRP035), the same having been filed on May 12, 2015 as U.S. Application No. 14/710,103;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, an undersigned named inventor, hereby:

- 1) Sell, assign and transfer to **Amprius, Inc.**, a California corporation having a place of business at 225 Humboldt Court, Sunnyvale, CA 94089 ("ASSIGNEE"), the entire right, title and interest in the above-referenced applications including any and all improvements and inventions disclosed therein, and in applications based upon, and patents (including foreign patents and the right to claim priority) granted upon, the above-referenced applications.
- 2) Authorize and request the Commissioner of Patents to issue any and all Letters Patents resulting from said applications or any division, continuation, substitute, renewal, re-examination or reissue thereof to the ASSIGNEE.
- 3) Agree to execute all papers and documents and, entirely at the ASSIGNEE's expense, perform any acts which are reasonably necessary in connection with the prosecution of said applications, as well as any derivative applications thereof, foreign applications based thereon, and/or the enforcement of patents resulting from such applications.
- 4) Agree that the terms, covenants and conditions of this assignment shall inure to the benefit of the ASSIGNEE, its successors, assigns and other legal representative, and shall be binding upon the named inventor, as well as the named inventor's heirs, legal representatives and assigns.
- 5) Warrant and represent that I have not entered, and will not enter into any assignment, contract, or understanding that conflicts with this assignment.

Signed on the date indicated beside my signature.

- 1) Signature: Weijie Wang Date: 05/22/15
Typed Name: Weijie Wang
- 2) Signature: Zuqin Liu Date: 05/29/15
Typed Name: Zuqin Liu
- 3) Signature: Song Han Date: 5/22/15
Typed Name: Song Han
- 4) Signature: Jonathan Bornstein Date: 5/26/15
Typed Name: Jonathan Bornstein
- 5) Signature: Constantin Ionel Stefan Date: 5/22/2015
Typed Name: Constantin Ionel Stefan